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Vishay/Siliconix IRLL014

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Datasheet of IRLL014 - MOSFET N-CH 60V 2.7A SOT223

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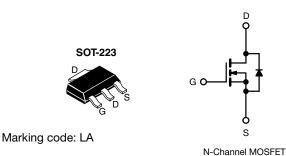
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HALOGEN

FREE

### **Power MOSFET**

PRODUCT SUMM	ARY	
V <sub>DS</sub> (V)	60	
$R_{DS(on)}(\Omega)$	$V_{GS} = 5.0 \text{ V}$	0.20
Q <sub>g</sub> max. (nC)	8.4	
Q <sub>gs</sub> (nC)	3.5	j
Q <sub>gd</sub> (nC)	6.0	)
Configuration	Sing	le



#### **FEATURES**

- Surface mount
- Available in tape and reel
- Dynamic dV/dt rating
- Logic-level gate drive
- R<sub>DS(on)</sub> specified at V<sub>GS</sub> = 4 V and 5 V
- Fast switching
- Ease of paralleling
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912">www.vishav.com/doc?99912</a>

#### **DESCRIPTION**

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The SOT-223 package is designed for surface-mounting using vapor phase, infrared, or wave soldering techniques. Its unique package design allows for easy automatic pick-and-place as with other SOT or SOIC packages but has the added advantage of improved thermal performance due to an enlarged tab for heatsinking. Power dissipation of greater than 1.25 W is possible in a typical surface mount application.

ORDERING INFORMATION	
Package	SOT-223
Lead (Pb)-free and Halogen-free	SiHLL014TR-GE3
Lead (Pb)-free	IRLL014TRPbF <sup>a</sup>

#### Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS ( $T_C$	= 20 0, arriess otherwis			1	
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		$V_{DS}$	60	V	
Gate-Source Voltage		$V_{GS}$	± 10	V	
Continuous Drain Current	$V_{GS}$ at 10 V $T_{C} = 25 ^{\circ}\text{C}$		2.7		
Continuous Drain Current $V_{GS}$ at 10 V $T_{C} = 100$		l <sub>D</sub>	1.7	Α	
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	22		
Linear Derating Factor			0.025	W/°C	
Linear Derating Factor (PCB mount) e			0.017		
Single Pulse Avalanche Energy <sup>b</sup>		E <sub>AS</sub>	100	mJ	
Repetitive Avalanche Current <sup>a</sup>		I <sub>AR</sub>	2.7	Α	
Repetitive Avalanche Energy <sup>a</sup>		E <sub>AR</sub>	0.31	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C	В	3.1	W	
Maximum Power Dissipation (PCB mount) e	T <sub>A</sub> = 25 °C	$P_{D}$	2.0		
Peak Diode Recovery dV/dt c		dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	- °C	
Soldering Recommendations (Peak temperature) d for 10 s			300		

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD} = 25 \text{ V}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ ,  $L = 16 \,\text{mH}$ ,  $R_g = 25 \,\Omega$ ,  $I_{AS} = 2.7 \,\text{A}$  (see fig. 12).
- c.  $I_{SD} \le 10$  A,  $dI/dt \le 90$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C.
- d. 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).



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THERMAL RESISTANCE RATI	NGS				
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient (PCB mount) <sup>a</sup>	R <sub>thJA</sub>	-	-	60	°C/W
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	-	40	

#### Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static				l	l .			
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 250 μA	60	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	ce to 25 °C, I <sub>D</sub> = 1 mA	-	0.073	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	1.0	-	2.0	V	
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 10 V	-	-	± 100	nA	
7 0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1		V <sub>DS</sub>	= 60 V, V <sub>GS</sub> = 0 V	-	-	25	_	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 48 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	250	μΑ	
Drain-Source On-State Resistance		V <sub>GS</sub> = 5.0 V	I <sub>D</sub> = 1.6 A <sup>b</sup>	-	-	0.20		
	R <sub>DS(on)</sub>		I <sub>D</sub> = 1.4 A <sup>b</sup>	-	-	0.28	Ω	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 25 V, I <sub>D</sub> = 1.6 A	3.2	-	-	S	
Dynamic				L	l			
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		-	400	-		
Output Capacitance	C <sub>oss</sub>			-	170	-	рF	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1	f = 1.0 MHz, see fig. 5		42	-	1	
Total Gate Charge	Qg			-	-	8.4		
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 5.0 \text{ V}$	$I_D = 10 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 b	-	-	3.5	nC	
Gate-Drain Charge	Q <sub>gd</sub>		See lig. 0 and 15	-	-	6.0	1	
Turn-On Delay Time	t <sub>d(on)</sub>		•	-	9.3	-		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 30 V, $I_{D}$ = 10 A, $R_{g}$ = 12 $\Omega$ , $R_{D}$ = 2.8 $\Omega$ , see fig. 10 $^{b}$		-	110	-	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	17	-		
Fall Time	t <sub>f</sub>			-	26	-		
Internal Drain Inductance	L <sub>D</sub>	Between lead 6 mm (0.25")	·	-	4.0	-	ml I	
Internal Source Inductance	L <sub>S</sub>	package and center of die contact		-	6.0	-	- nH	
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	2.7	- A	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	22	_ A	
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 2.7 A, V <sub>GS</sub> = 0 V b		-	-	1.6	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 05 °C !	40.4 41/4± 400.4/: b	-	65	130	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25  ^{\circ}\text{C}, I_F = 10  \text{A}, dI/dt = 100  \text{A/}\mu\text{s}^{\text{b}}$		-	0.33	0.65	μC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	ırn-on time is negligible (turn	on is dor	ninated b	v Ls and	L <sub>D</sub> )	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$  2 %.

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

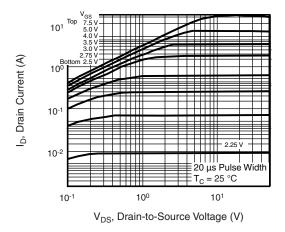


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

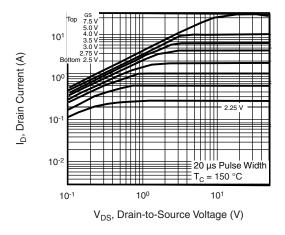


Fig. 2 - Typical Output Characteristics,  $T_C = 150 \, ^{\circ}\text{C}$ 

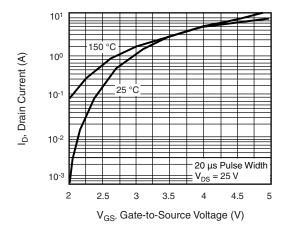


Fig. 3 - Typical Transfer Characteristics

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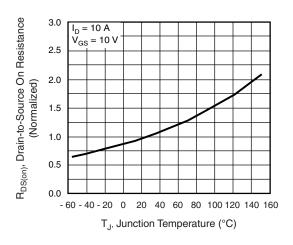


Fig. 4 - Normalized On-Resistance vs. Temperature

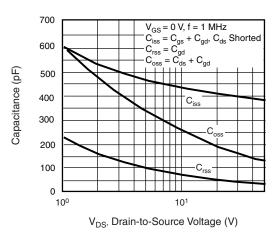


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

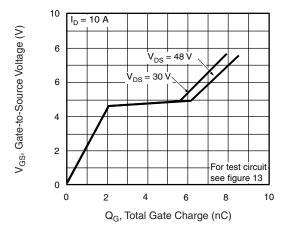


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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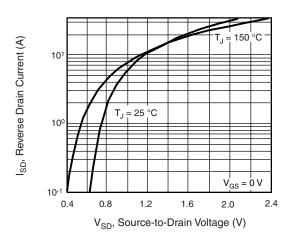


Fig. 7 - Typical Source-Drain Diode Forward Voltage

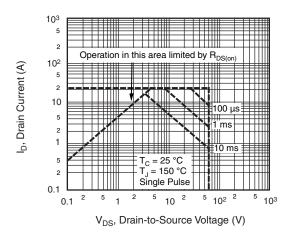


Fig. 8 - Maximum Safe Operating Area

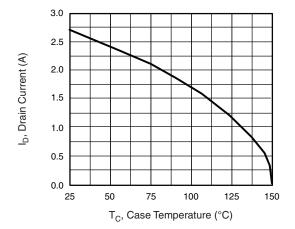


Fig. 9 - Maximum Drain Current vs. Case Temperature

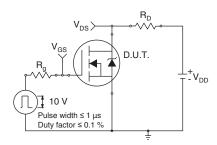


Fig. 10a - Switching Time Test Circuit

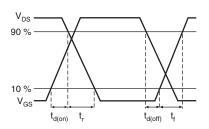


Fig. 10b - Switching Time Waveforms



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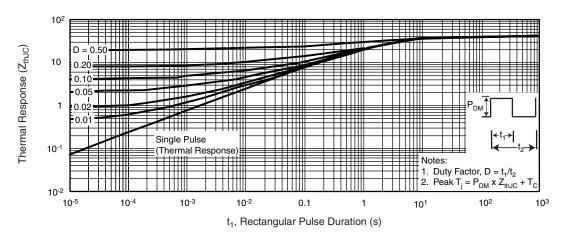


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

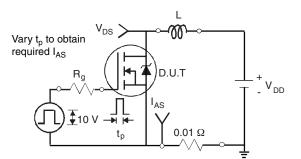


Fig. 12a - Unclamped Inductive Test Circuit

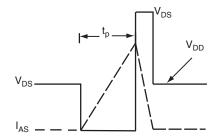


Fig. 12b - Unclamped Inductive Waveforms

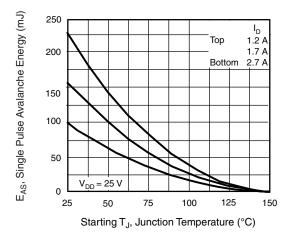


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

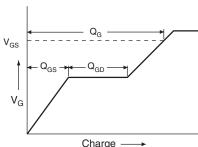
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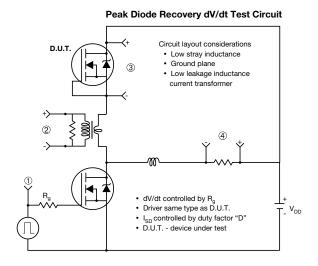


D.U.T. V<sub>GS</sub> > Charge Current sampling resistors

Fig. 13a - Basic Gate Charge Waveform

Fig. 13b - Gate Charge Test Circuit

Current regulator Same type as D.U.1



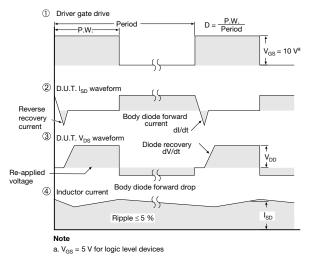


Fig. 14 - For N-Channel

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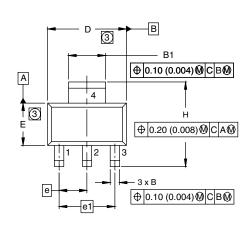
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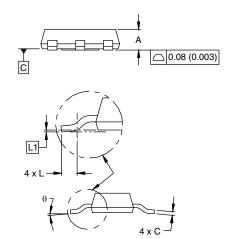


### **Package Information**

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#### **SOT-223 (HIGH VOLTAGE)**





	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
Α	1.55	1.80	0.061	0.071
В	0.65	0.85	0.026	0.033
B1	2.95	3.15	0.116	0.124
С	0.25	0.35	0.010	0.014
D	6.30	6.70	0.248	0.264
Е	3.30	3.70	0.130	0.146
е	2.30	2.30 BSC		5 BSC
e1	4.60	4.60 BSC		BSC
Н	6.71	7.29	0.264	0.287
L	0.91	-	0.036	-
L1	0.061 BSC		0.0024	4 BSC
θ	-	10'	-	10'

ECN: S-82109-Rev. A, 15-Sep-08

DWG: 5969

#### Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension do not include mold flash.
- 4. Outline conforms to JEDEC outline TO-261AA.

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